

Morgan Stanley

# Semi Industry Forum 4.0: What happens next?

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## **Renaissance Period for Semiconductors**

Strong Secular Demand Drivers

**Tight Supply Exacerbated by COVID Impact** 

Geopolitical Issues Driving Government Support

**Consolidation From M&A Creating Scarcity Value** 

**Power Within Tech Sector Shifting To Semiconductors** 



## **New Golden Age for Semiconductors**

#### 1,000 Mobile Industry 4.0 + Everywhere Platforms driving 750 semiconductor demand + Mobile Autonomous Cloud / **Semiconductor Market** Datacenter Vehicles **Expected to Grow to** 500 + Datacenter + Networking By the End of Gaming AR / VR 5G this Decade 250 PC Smart Home AI / ML <u>()</u> 0 '15 '20 '25 '85 '90 '95 '00' '05 '10 **Compute-centric** Pervasive

#### **Broad Range of Secular Megatrends Driving Semiconductor Industry Growth Acceleration to Support Digital Transformation**

Source: Statista, IDC Worldwide Semiconductor Forecast Update May 2021

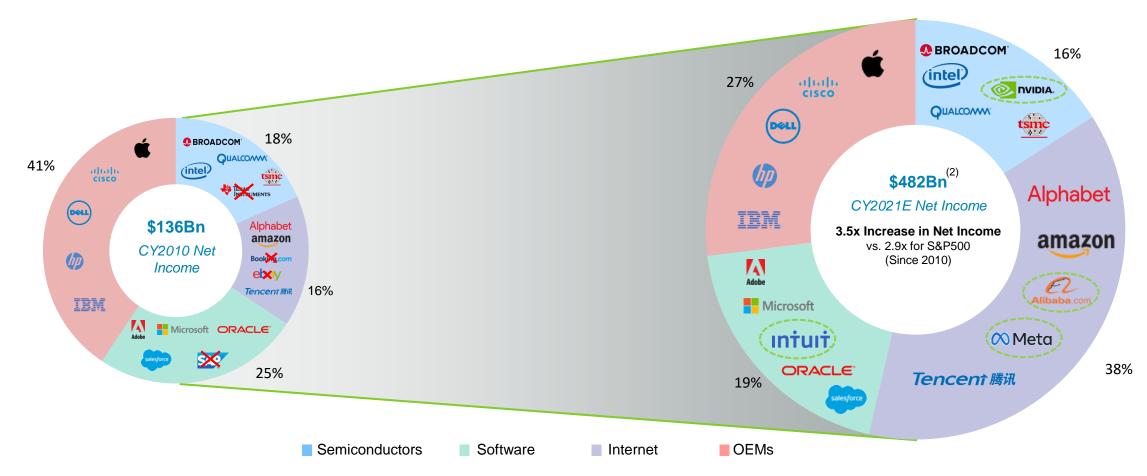
**New Golden Age for Semiconductors** 

Semiconductor Industry Revenue, \$Bn

Source: IDC Worldwide Semiconductor Forecast Update May 2021



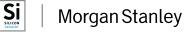
## Few Changes in Players but Dramatic Shift in Composition of Largest Tech Companies Since 2010



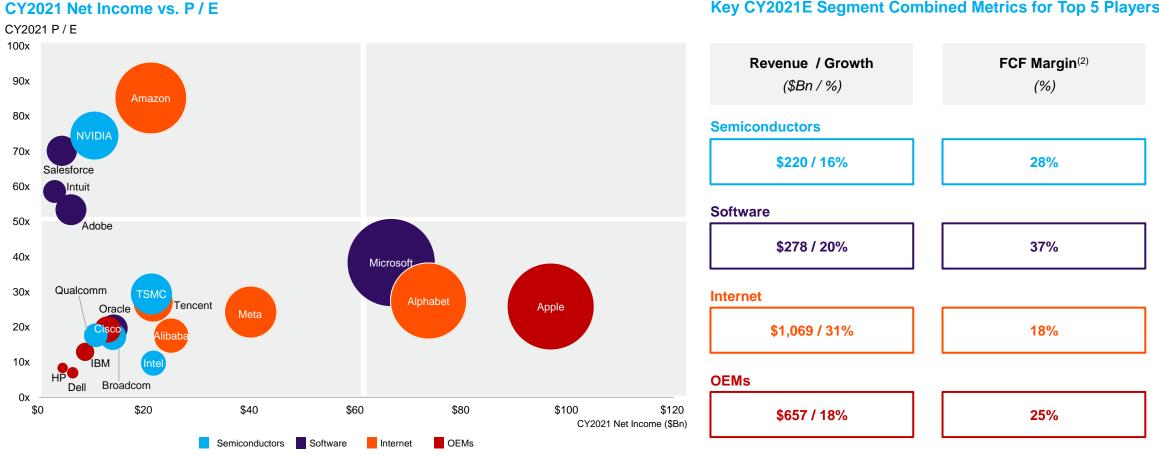
Source: Capital IQ; charts represent the aggregate net income contribution of the 5 largest tech companies in each industry vertical based on largest market cap as of the measurement date

Notes:

As of 8/17/2020
Market data as of 11/11/2021



## Largest Semiconductor Companies Growing Slower than **Tech Peers but Generating Significant Free Cash Flow**



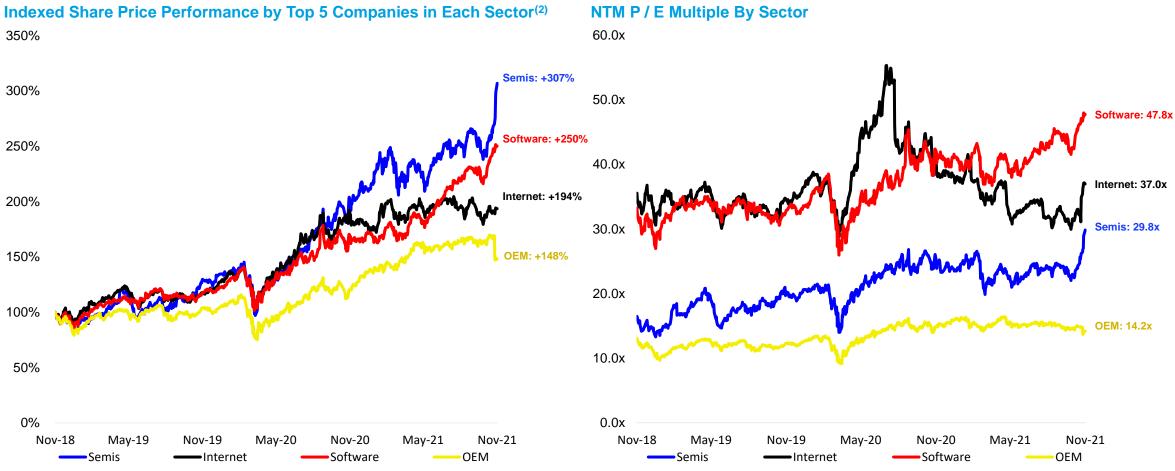
Size of Bubble = Market Cap

Key CY2021E Segment Combined Metrics for Top 5 Players

Notes: 1. Market data and Thomson estimates as of 11/8/2021 2. Defined as EBITDA - Capex

## **Top Semiconductor Companies have Meaningfully Outperformed Peers in Other Tech Sectors**

Last 3 Years



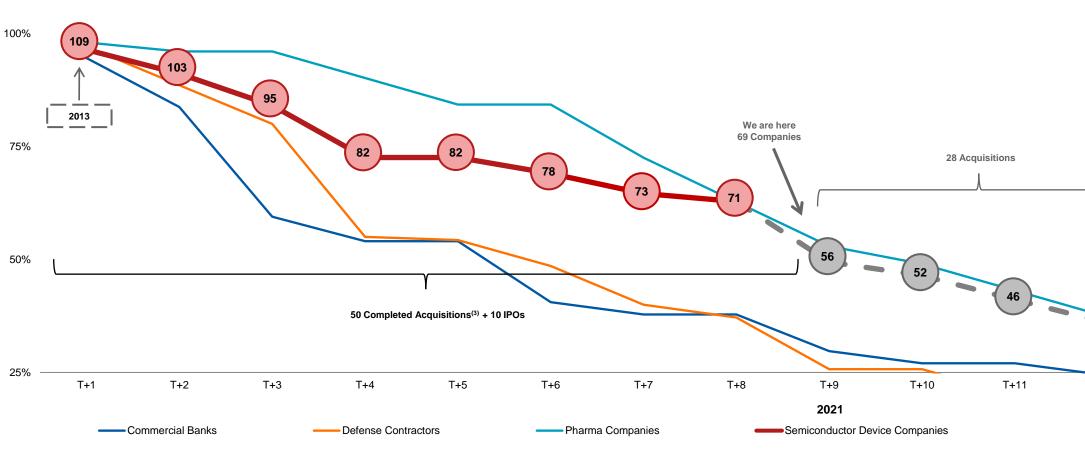
#### Notes:

1. Market data and Refinitiv consensus as of 11/8/2021

2. Top 5 companies by market cap. Semis companies include: NVIDIA, TSMC, Qualcomm, Broadcom, Intel. Internet companies include: Amazon, Alphabet, Tencent, Meta, Alibaba. Software companies include: Microsoft, Adobe, Salesforce, Oracle, Intuit. OEM companies include: Apple, Cisco, IBM, Dell, HP

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## **Secular Consolidation Trend Should Continue**



All Companies on a Relative Basis as a % of Initial Consolidation 2013 – 2024E

Notes:

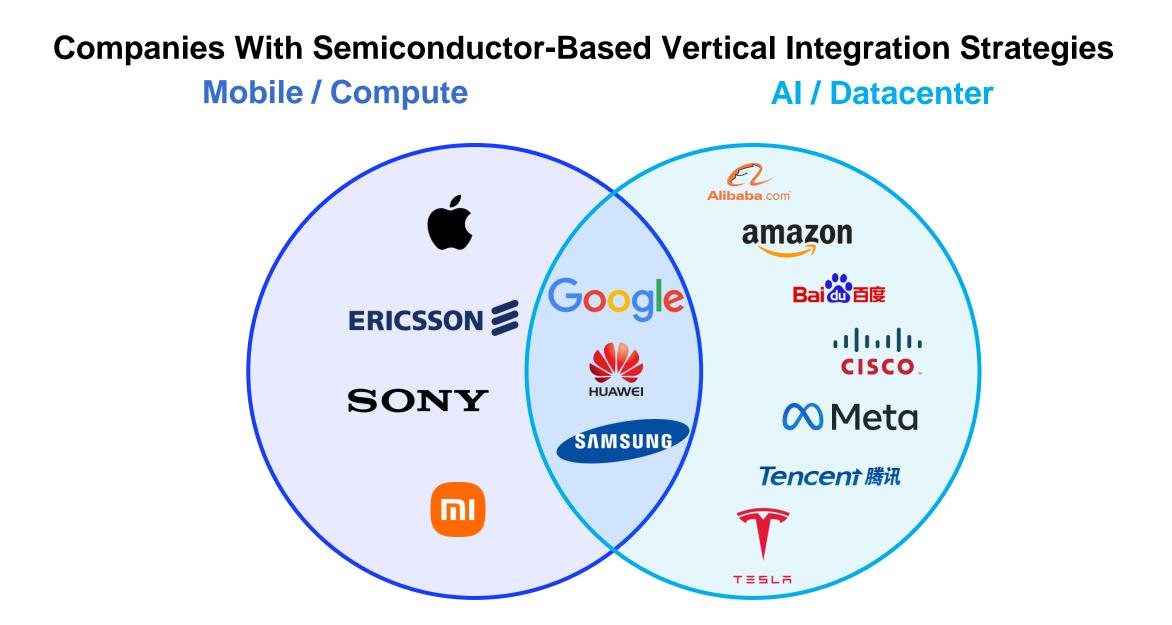
Market Data as of November 2021
Excludes Chinese IPOs since 2013

Excludes of mese in os since 2013
Excludes 4 companies with less than \$100MM in revenue at time of acquisition



41

T+12



## **Pros and Cons of Vertical Integration**

Pros			Cons	
$\checkmark$	Differentiation of end product or service features	×	Structurally lower margins than software and services businesses	
$\checkmark$	Potential time-to-market advantages	×	Lack of scale and breadth creates inefficiencies	
$\checkmark$	Eliminate margin stack to IC suppliers	×	Poor execution will likely harm overall business and destroy value	
$\checkmark$	Opportunity to better control destiny	×	Merchant suppliers should be able to lead and out-innovate captive players	



# **GlobalFoundries is A Microcosm of How the Balance of Power is Shifting in Semiconductors**

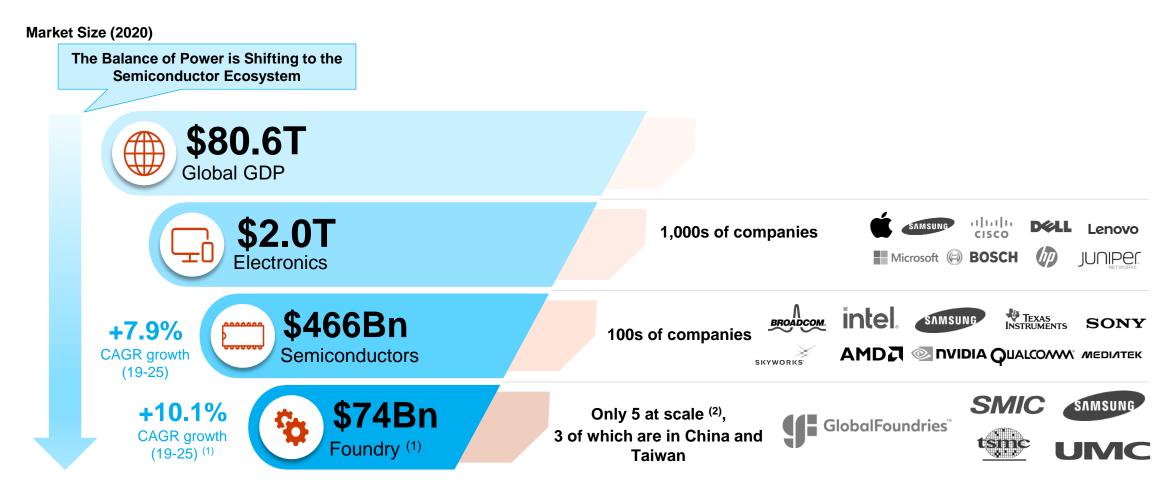
## Select Customer Commitments

	Year Signed	Contract Duration (Years)	Revenue Commitment (\$Bn)	Technology	Core End Products
Customer 1	2021	4	>\$3.0	FinFET, CMOS, BCD CMOS, FDX™, RF SOI	Various Mobile Products
Customer 2	2021	6	>\$2.5	eNVM CMOS	NFC and UWB Secure Element, Secure Cards
Customer 3	2021	3	>\$1.5	FinFET	Various Computing Products, Automotive Processors
Customer 4	2021	4	>\$1.5	eNVM CMOS	Automotive MCU, Secure Cards
Customer 5	2021	4	>\$1.5	RF SOI	Various Mobile Products
Customer 6	2020 / 2021	4	>\$1.5	FinFET, CMOS	High-End Image Sensor and DTV Processor
Customer 7	2021	5	>\$1.5	BCD CMOS	Mobile Audio, Haptic and Power
Customer 8	2021	5	>\$1.0	FinFET	Various Computing Products
Customer 9	2021	4	>\$1.0	CMOS, FDX™	Various Mobile Products
Customer 10	2020 / 2021	5	>\$1.0	CMOS	Image Sensor Processors
Customer 11	2021	4	>\$0.5	FinFET	Network and Connectivity Infrastructure Processors
Customer 12	2021	3	>\$0.5	RF SOI, SiGe, BCDLite™	Various Mobile Products

>\$2.5Bn in Advanced Payments and Capacity Reservation Fees <sup>(1)</sup>

Notes: 1. As of 11/1/2021

## Semiconductors Will Become Increasingly More Powerful Within the Tech Sector



Source: Derived from Gartner data. Gartner Forecast, Semiconductor Foundry Revenue Supply and Demand Worldwide 2Q21 Update, July 2021

Notes:

1. Excluding memory

2. Excludes smaller foundry players, defined as those with less than \$2Bn of foundry revenue (e.g., Intel, Skywater, Tower, WIN)



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